

PRELIMINARY
Notice: This is not a final specification.
Some parametric limits are subject to change.

GCU40AB-90HIGH POWER INVERTER USE
PRESS PACK TYPE**GCU40AB-90**

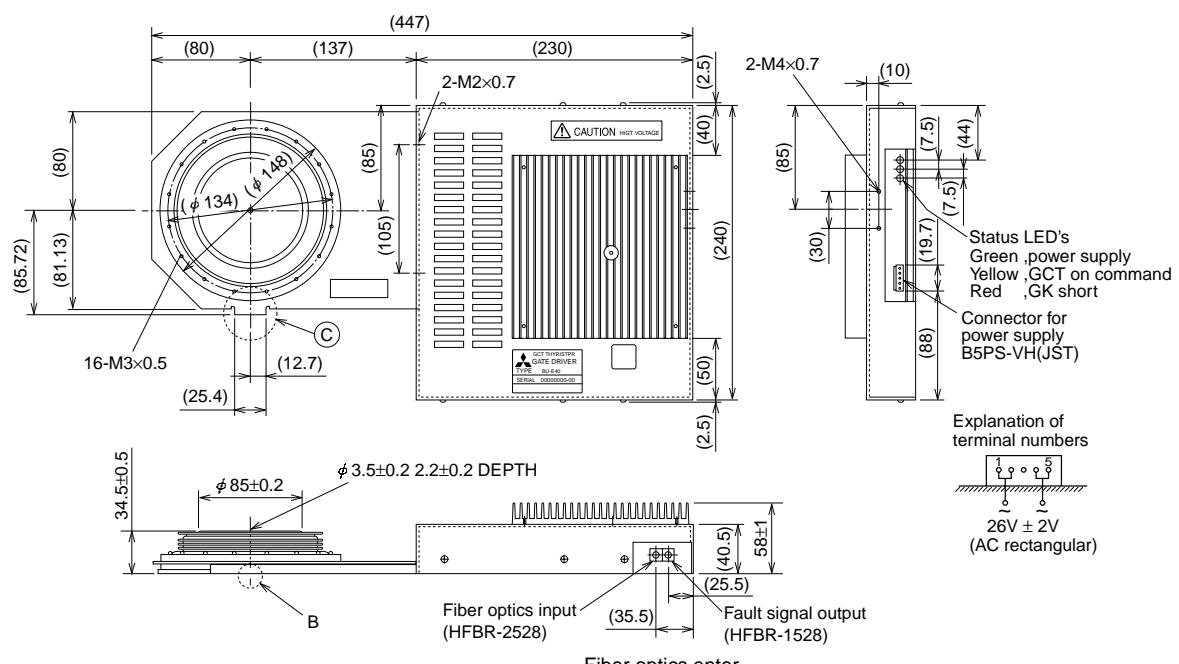
- Asymmetrical GCT unit
- GCT and Gate driver are connected
- ITQRM Repetitive controllable on-state current 4000A
- IT(AV) Average on-state current 1200A
- VDRM Repetitive peak off-state voltage 4500V
- VRM Repetitive peak reverse voltage 21V

APPLICATION

Inverters, DC choppers, Induction heaters, DC to DC converters.

OUTLINE DRAWING

Dimensions in mm



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GCU40AB-90**HIGH POWER INVERTER USE
PRESS PACK TYPE****GCT PART (Type name : FGC4000BX-90DS)****MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Voltage class	Unit
V _{RRM}	Repetitive peak reverse voltage	—	21	V
V _{RSM}	Non-repetitive peak reverse voltage	—	21	V
V _{DRM}	Repetitive peak off-state voltage	V _{GK} = -2V	4500	V
V _{DSD}	Non-repetitive peak off-state voltage	V _{GK} = -2V	4500	V
V _{LTDs}	Long term DC stability voltage	V _{GK} = -2V, $\lambda = 100$ Fit	3600	V

Symbol	Parameter	Conditions	Ratings	Unit
I _{TQRM}	Repetitive controllable on-state current	V _D = 4500V, V _D = 2250V, V _{RG} = 20V, L _C = 0.3μH T _j = 25/125°C, With GU-E40 (see Fig. 1, 3)	4000	A
I _{T(RMS)}	RMS on-state current	Applied for all condition angles	1800	A
I _{T(AV)}	Average on-state current	f = 60Hz, sinewave θ = 180°, T _f = 70°C	1200	A
I _{TSM}	Surge on-state current		25	kA
I ² t	Current-squared, time integration	One half cycle at 60Hz, T _j = 125°C Start	2.6 × 10 ⁶	A ² s
dI/dt	Critical rate of rise of on-state current	V _D = 2250V, I _T = 4000A, T _j = 25/125°C, f = 60Hz With GU-E40 (see Fig. 1, 2)	1000	A/μs
V _{FGM}	Peak forward gate voltage		10	V
V _{RGM}	Peak reverse gate voltage		21	V
I _{FGM}	Peak forward gate current		1000	A
I _{RGM}	Peak reverse gate current		3500	A
P _{FGM}	Peak forward gate power dissipation		10	kW
P _{PRGM}	Peak reverse gate power dissipation		120	kW
P _{F(G)} (AV)	Average forward gate power dissipation		200	W
P _{R(G)} (AV)	Average reverse gate power dissipation		630	W
T _j	Operation junction temperature		-20 ~ +125	°C
T _{stg}	Storage temperature		-20 ~ +150	°C
—	Mounting force required	(Recommended value 40kN)	32 ~ 48	kN
—	Weight	Typical value	1500	g

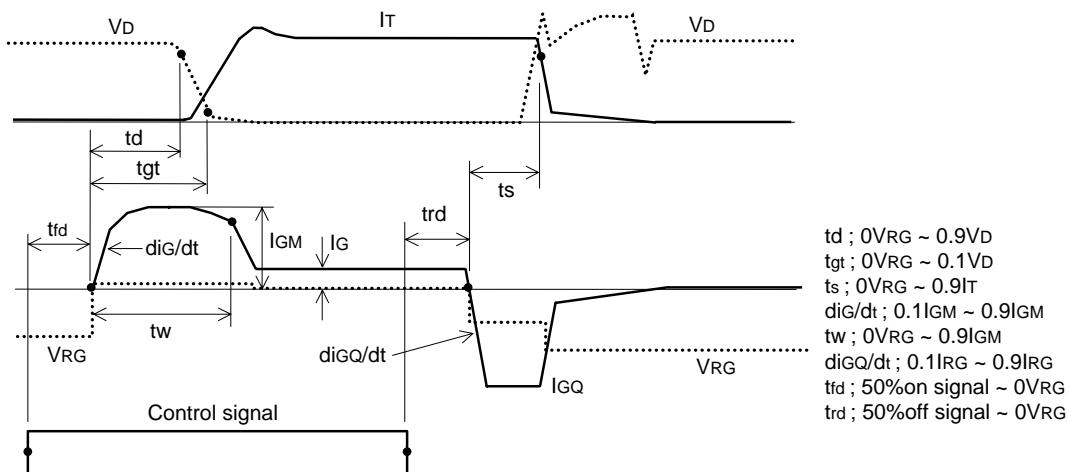
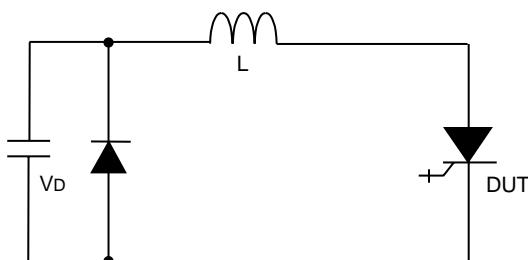
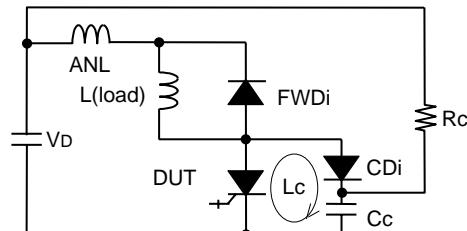
ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	Limits			Unit
			Min	Typ	Max	
V _{TM}	On-state voltage	I _T = 4000A, T _j = 125°C	—	—	4.0	V
I _{RRM}	Repetitive peak reverse current	V _{RM} = 21V, T _j = 125°C	—	—	100	mA
I _{DRM}	Repetitive peak off-state current	V _D = 4500V, V _{GK} = -2V, T _j = 125°C	—	—	150	mA
I _{GRM}	Reverse gate current	V _{RG} = 21V, T _j = 125°C	—	—	100	mA
dV/dt	Critical rate of rise of off-state voltage	V _D = 2250V, V _{GK} = -2V, T _j = 125°C (Expo. wave)	3000	—	—	V/μs
t _{gt}	Turn-on time	VD = 2250V, IT = 4000A, dI/dt = 1000A/μs, T _j = 125°C With GU-E40 (see Fig. 1, 2)	—	—	3.0	μs
t _d	Turn-on delay time		—	—	1.0	μs
E _{on}	Turn-on switching energy		—	1.0	—	J/P
t _s	Storage time	V _D = 4500V, V _D = 2250V, IT = 4000A VRG = 20V, T _j = 125°C With GU-E40 (see Fig. 1, 3)	—	—	3.0	μs
E _{off}	Turn-off switching energy		—	13	—	J/P
I _{GT}	Gate trigger current		—	—	2.5	A
V _{GT}	Gate trigger voltage	VD = 24V, RL = 0.1Ω, T _j = 25°C DC method	—	—	1.5	V
R _{th(j-f)}	Thermal resistance		Junction to Fin	—	0.011	K/W

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GATE DRIVER PART (Type name : GU-E40)

Symbol	Parameter	Conditions	Limits			Unit
			Min	Typ	Max	
VC	Power supply voltage (Note 1)	AC rectangular, f = 15kHz ~ 100kHz or DC power supply	25.2	28	32.2	V
IC	Power supply current (Note 1)	IT = 1500Arms, f = 500Hz, duty = 0.5	—	—	5	A
—	Control signal	Optical fiber data link Transmitter : HFBR-1528 (HP) Receiver : HFBR-2528 (HP)	—	—	—	—
f	Frequency	IT = 1500Arms, duty = 0.5	—	—	500	Hz
td	Delay time of on gate current	Ta = 25°C	—	—	2.0	μs
trd	Delay time of off gate current	Ta = 25°C	—	—	2.0	μs
dig/dt	Critical rate of rise of on gate current		100	—	—	A/μs
IGM	Peak on gate current		—	200	—	A
tw	Width of on high gate current		5	—	—	μs
IG	On gate current	Tj ≥ -10°C	10	—	—	A
digQ/dt	Critical rate of rise of off gate current	VRG= 20V	—	6000	—	A/μs
Dmax	Maximum duty		—	—	100	%
Ta	Temperature	Operation temperature (Recommend : ≤ 40°C)	-10	—	+60	°C
—	Weight	With FGC4000BX-90DA	—	5300	—	g
Rth(j-f)	Thermal resistance (Junction to Fin) (Note 2)	With FGC4000BX-90DA	—	—	0.012	K/W
—	Status signal (Note 3)		—	—	—	—

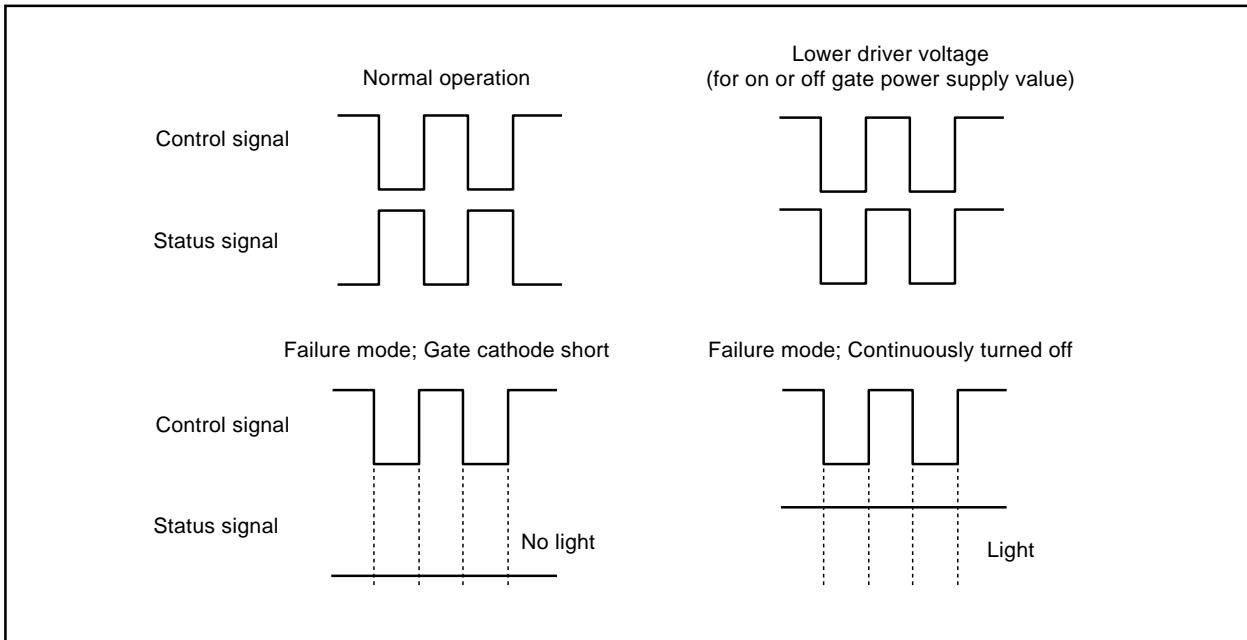
**Fig. 1 Turn-on and Turn-off waveform****Fig. 2 Turn-on test circuit****Fig. 3 Turn-off test circuit**
(With clamp circuit)

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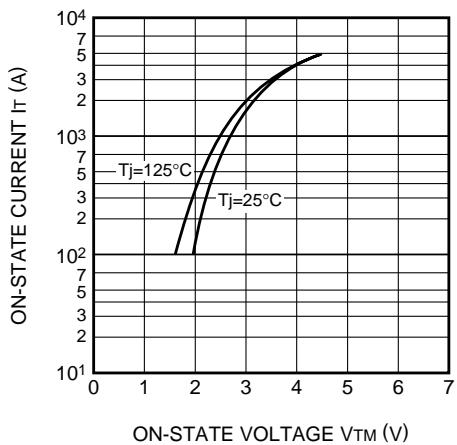
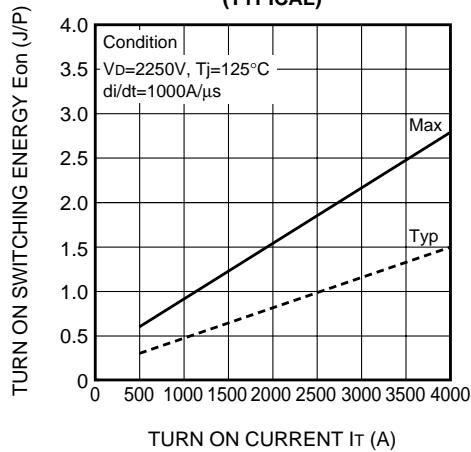
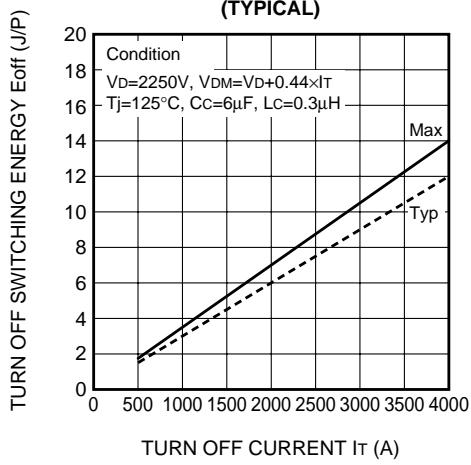
GCU40AB-90**HIGH POWER INVERTER USE
PRESS PACK TYPE**

- Note 1. Main current condition of GCT Thyristor is 1500Arms, duty = 0.5, f = 500Hz.
2. If GU-E40 and FGC4000BX-90DS are used together, Rth(j-f) becomes 0.012K/W.
 (Only FGC4000BX-90DS is used, Rth(j-f) becomes 0.011K/W)
 3. Status signal from gate driver
 - (1) Status signal of LED

Green : Power supply
Yellow: GCT on command
Red : GK short
 - (2) status signal of Optic Transmitter



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GCU40AB-90**HIGH POWER INVERTER USE
PRESS PACK TYPE****PERFORMANCE CURVES****MAXIMUM ON-STATE CHARACTERISTIC****E_{on} VS I_T
(TYPICAL)****E_{off} VS I_T
(TYPICAL)****MAXIMUM THERMAL IMPEDANCE
CHARACTERISTIC
(JUNCTION TO FIN)**